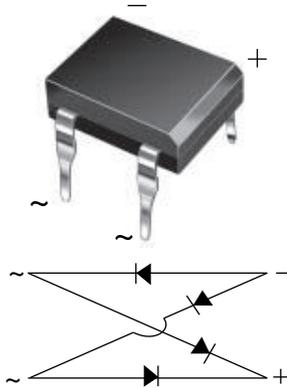




Miniature Glass Passivated Single-Phase Bridge Rectifiers



Case Style DFM

FEATURES

- UL recognition, file number E54214
- Ideal for printed circuit boards
- Applicable for automated insertion
- High surge current capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for SMPS, lighting ballaster, adapter, battery charger, home appliances, office equipment, and telecommunication applications.

MECHANICAL DATA

Case: DFM

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked on body

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | |
|-------------------------|---|
| $I_{F(AV)}$ | 1 A |
| V_{RRM} | 50 V, 100 V, 200 V, 400 V, 600 V, 800 V, 1000 V |
| I_{FSM} | 50 A |
| I_R | 5 μ A |
| V_F at $I_F = 1.0$ A | 1.1 V |
| T_J max. | 150 °C |
| Package | DFM |
| Circuit configuration | Quad |

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | | | | | | | |
|--|----------------|-------------|-------|-------|-------|-------|-------|-------|------------------|
| PARAMETER | SYMBOL | DF005M | DF01M | DF02M | DF04M | DF06M | DF08M | DF10M | UNIT |
| Device marking code | | DF005 | DF01 | DF02 | DF04 | DF06 | DF08 | DF10 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V_{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | V_{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum average forward output rectified current at $T_A = 40$ °C | $I_{F(AV)}$ | 1.0 | | | | | | | A |
| Peak forward surge current single sine-wave superimposed on rated load | I_{FSM} | 50 | | | | | | | A |
| Rating for fusing ($t < 8.3$ ms) | I^2t | 10 | | | | | | | A ² s |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +150 | | | | | | | °C |



| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | | | | |
|--|-------------------------|----------------|--------|-------|-------|-------|-------|-------|-------|------|----|
| PARAMETER | TEST CONDITIONS | SYMBOL | DF005M | DF01M | DF02M | DF04M | DF06M | DF08M | DF10M | UNIT | |
| Maximum instantaneous forward voltage drop per diode | 1.0 A | V _F | 1.1 | | | | | | | | V |
| Maximum reverse current at rated DC blocking voltage per diode | T _A = 25 °C | I _R | 5.0 | | | | | | | | μA |
| | T _A = 125 °C | | 500 | | | | | | | | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | C _J | 25 | | | | | | | | pF |

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | | |
|---|------------------|--------|-------|-------|-------|-------|-------|-------|------|
| PARAMETER | SYMBOL | DF005M | DF01M | DF02M | DF04M | DF06M | DF08M | DF10M | UNIT |
| Typical thermal resistance ⁽¹⁾ | R _{θJA} | 40 | | | | | | | °C/W |
| | R _{θJL} | 15 | | | | | | | |

Note

⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead mounted on PCB with 0.5" x 0.5" (13 mm x 13 mm) copper pads

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|---------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| DF06M-E3/45 | 0.416 | 45 | 50 | Tube |



RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

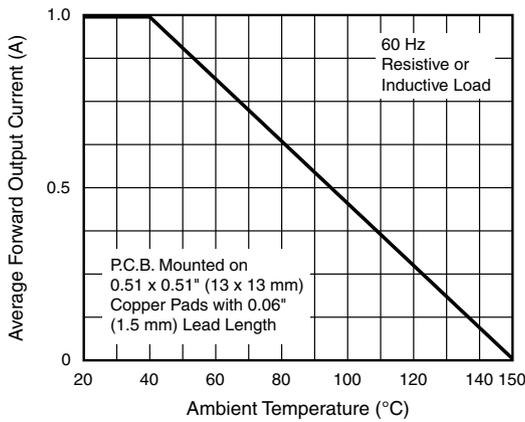


Fig. 1 - Derating Curve Output Rectified Current

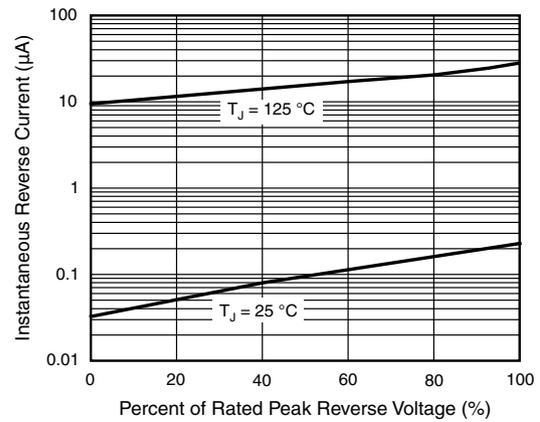


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

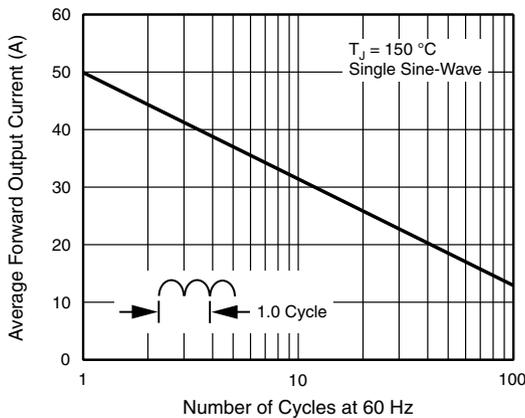


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

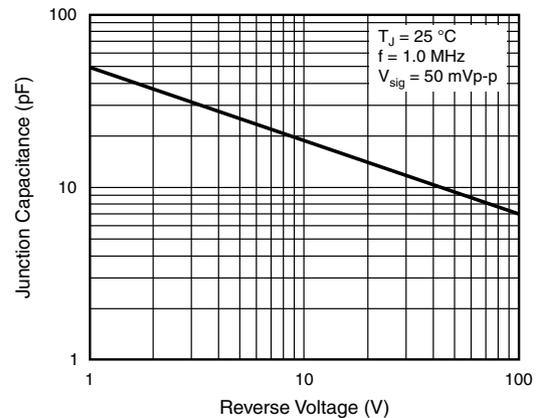


Fig. 5 - Typical Junction Capacitance Per Diode

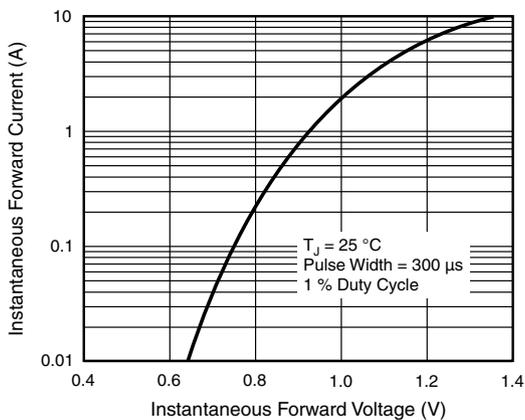


Fig. 3 - Typical Forward Characteristics Per Diode

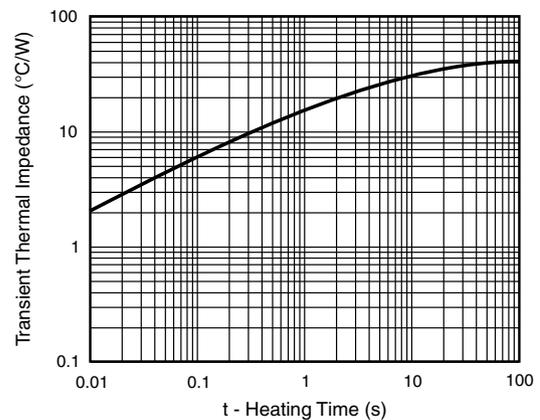
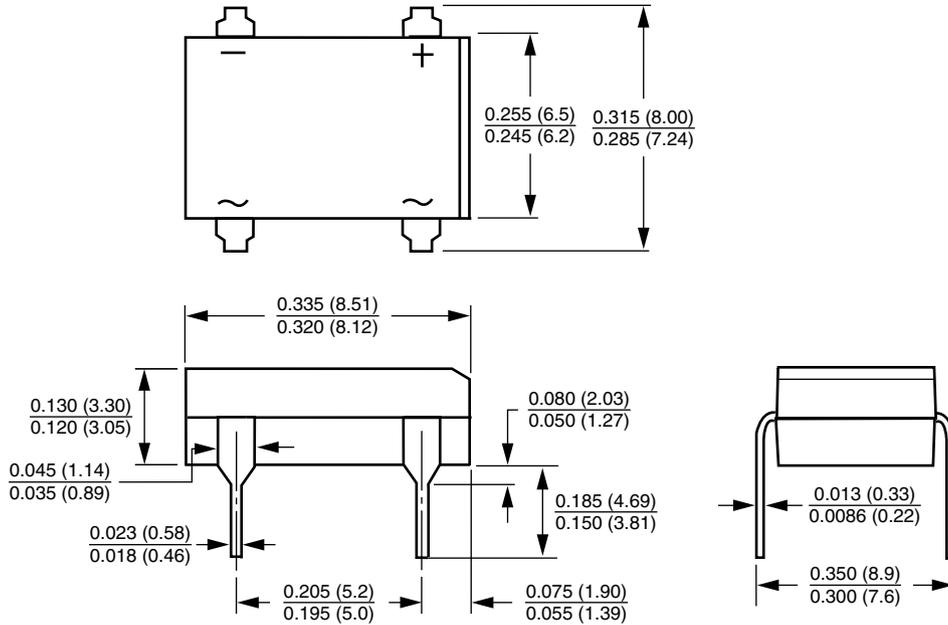


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

Case Style DFM





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